

**GLASS PASSIVATED BRIDGE RECTIFIERS**

REVERSE VOLTAGE - 50 to 1000 Volts  
FORWARD CURRENT - 20 Amperes

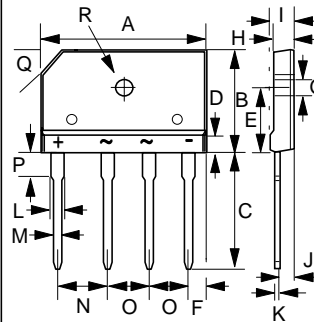
**FEATURES**

- Rating to 1000V PRV
- Ideal for printed circuit board
- Low forward voltage drop, high current capability.
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- The plastic material has UL flammability classification 94V-0
- UL Recognition File # E95060

**MECHANICAL DATA**

- Polarity : Symbols molded on body
- Weight : 0.23 ounces, 6.6 grams
- Mounting position : Any

**GBJ**



GBJ		
DIM.	MIN.	MAX.
A	29.70	30.30
B	19.70	20.30
C	17.0	18.0
D	4.70	4.90
E	10.80	11.20
F	2.30	2.70
G	3.10	3.40
H	3.40	3.80
I	4.40	4.80
J	2.50	2.90
K	0.60	0.80
L	2.00	2.40
M	0.90	1.10
N	9.80	10.20
O	7.30	7.70
P	3.80	4.20
Q	(3.0) x 45°	
R	3.10 $\phi$	3.40 $\phi$

All Dimensions in millimeter

**MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS**

Ratings at 25°C ambient temperature unless otherwise specified.  
Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	GBJ 20005	GBJ 2001	GBJ 2002	GBJ 2004	GBJ 2006	GBJ 2008	GBJ 2010	UNIT
Maximum Recurrent Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward (with heatsink Note 2) Rectified Current @Tc =100°C (without heatsink)	I(AV)	20.0 3.6							A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC METHOD)	IFSM	240							A
Maximum forward Voltage at 10.0A DC	VF	1.05							V
Maximum DC Reverse Current @TJ =25°C at Rated DC Blocking Voltage @TJ =125°C	IR	10 500							uA
I <sup>2</sup> t Rating for fusing (t < 8.3ms)	I <sup>2</sup> t	240							A <sup>2</sup> S
Typical Junction Capacitance per element (Note 1)	CJ	60							pF
Typical Thermal Resistance (Note 2)	R $\theta$ JC	0.8							°C/W
Operating Temperature Range	TJ	-55 to +150							°C
Storage Temperature Range	TSTG	-55 to +150							°C

NOTES : 1. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.  
2. Device mounted on 300mm x 300mm x 1.6mm Cu Plate Heatsink.

REV. 2, 01-Dec-2000, KBDG05

